



1746 SAH  
# 7e  
Patent 2-13-02  
253/236  
P00-0021

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

**BERGMAN, Eric J.**

Serial No.: 09/621,028

Filed: July 21, 2000

For: **PROCESS AND APPARATUS FOR  
TREATING A WORKPIECE SUCH AS A  
SEMICONDUCTOR WAFER**

) Group Art Unit: 1746

) Examiner: F. Stinson

CARRILLO

SECOND SUPPLEMENTAL PRELIMINARY AMENDMENT

Commissioner for Patents  
Washington, D.C. 20231

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FEB - 1 2001

TC 1700

Sir:

Further to the Preliminary Amendment filed February 9, 2001, enclosed is a Certified Copy of PCT/US99/08516.

Respectfully submitted,  
LYON & LYON LLP

Dated: December 7, 2001

By:

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Enclosures

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(37 C.F.R. §1.8a)

I hereby certify that this paper (along with any referred to as being attached or enclosed) is being deposited with the United States Postal Service on the date shown below with sufficient postage as First Class Mail in an envelope addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.

December 10, 2001

Date of Deposit

LA-220070.1

Laura Murphy  
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